





SPECIFICATION

Model: BH1917-0612J18W*S-KV4

Product dimensions

Unit : mm, tolerance±0.2 unless stated otherwise

Product characteristics

- 1) Good consistency of light color, high flux, high efficiency;
- 2) Low thermal resistance, good thermal stability;
- 3) Strong compatibility, easy to install and use;
- 4) High reliability;
- 5) LM-80 Certified and applied with RoHS standard
- 6) ANSI standards

Basic parameters \triangleright

| | | Ra | R9 | Lu | uminous | flux(LM) | Тур. | To us the survey of | 41 I |
|------------------------|-------|------|------|--------|---------|----------|------------------|---------------------|---------|
| | | | | TJ=85℃ | | TJ=25℃ | Lumens | Typ. | ulermai |
| Model | ССТ | Тур. | Min. | Min. | Тур. | Тур. | (LM/W) TJ=25℃ | current 电流(mA) | Rj(℃/W) |
| BH1917-0612J18W27S-KV4 | 2700K | 95 | 85 | 1870 | 2033 | 2259 | 121 | 540 | 0.83 |
| BH1917-0612J18W30S-KV4 | 3000K | 95 | 85 | 1968 | 2140 | 2378 | 127 | 540 | 0.83 |
| BH1917-0612J18W35S-KV4 | 3500K | 95 | 85 | 2040 | 2217 | 2464 | 132 | 540 | 0.83 |
| BH1917-0612J18W40S-KV4 | 4000K | 95 | 85 | 2012 | 2187 | 2430 | 130 | 540 | 0.83 |

Note: device tolerance 1) for luminous flux:±7%

2) Voltage±5%

3) device tolerance for color coordinate:±0.002 4) Ra/R9±2

Limit parameters

| Parameters | Symbol | Min | Тур | Max | Unit |
|-----------------------|--------|-----|------|------|---------|
| Forward V(Tյ=85℃) | Vf | 32 | 34.5 | 38 | V |
| Forward A | lf | - | 540 | 1380 | mA |
| Power (Tյ=85℃) | Pi | - | 18.6 | 52.4 | W |
| Junction Temp | Tj | - | - | 150 | °C |
| Attractions(HBM) | - | - | - | 8000 | V |
| View Angle | 201/2 | - | 120 | - | degrees |
| Operation Temperature | Тор | -20 | - | +85 | °C |
| Storage Temperature | Tst | -40 | - | +100 | °C |
| welding temperature | Tsol | - | - | 350 | °C |

*Ta=25℃ Bonding pad Tc≤85℃. In actual condition, silica gel surface temperature of **≤130**℃

> Reliability test curve

1、 Temperature Vs Lumen







2、 TCVS IF curve



4、Voltage Vs Current



5、Relative spectral curve







> White bins on CIE-1931



Color Temperature and BIN

| СТ | 2700K | 3000K | 3500K | 4000K | 4500K | 5000K | 5700K | 6500K |
|------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| CT Range | 2660-2790 | 2970-3125 | 3350-3575 | 3850-4110 | 4350-4640 | 4835-5235 | 5440-5920 | 6250-6850 |
| CT Factor | ±65 | ±77.5 | ±112.5 | ±130 | ±145 | ±200 | ±240 | ±300 |
| 并号 Bin NO. | L3 | M3 | N3 | O3 | P3 | Q3 | R3 | Т3 |

| ССТ | chromaticity | Central point | coordinates | long axisa | Short axis b | Rotation |
|-------|--------------|---------------|-------------|------------|--------------|----------|
| | tolerances | X | Y | long axioa | | Angle⊝ |
| 2700K | | 0.4578 | 0.4101 | 0.00774 | 0.00411 | 57.28 |
| 3000K | - | 0.4338 | 0.403 | 0.00834 | 0.00408 | 53.17 |
| 3500K | | 0.4073 | 0.3917 | 0.00951 | 0.00417 | 52.97 |
| 4000K | 3SDCM | 0.3818 | 0.3797 | 0.00939 | 0.00402 | 54.00 |
| 5000K | | 0.3447 | 0.3553 | 0.00822 | 0.00354 | 59.62 |
| 5700K | | 0.3287 | 0.3417 | 0.0081 | 0.003 | 61.00 |
| 6500K | | 0.3123 | 0.3282 | 0.00669 | 0.00285 | 58.38 |

Product color sorting test according to standard current, if using with other current, light/color will change. If customers need specific IEC standards, please let us know before placing an order. We will adjust the standards to meet your special requirements.

> Package and label illustration

1)

COB Packing : Tray +

Anti-static bag with vacuum packing + outer boxes



Plastic Tray

Vacuum bag packing

Outer Boxes

2) Box dimensions

| Box Size | Length (mm) | Width (mm) | Height (mm) |
|----------|-------------|------------|-------------|
| Big | 38.5 | 38.5 | 23 |
| Medium | 33 | 23 | 19 |

3) COB

| PN base | PCS/BOX | Tray/bag | Pcs/bag | Bag/ pcs Big box | bag/Pcs/Medium box |
|----------------------|---------|----------|---------|------------------|--------------------|
| BH1375/BH1311 | 36 | 5 | 180 | 24/4320 | 10/1800 |
| BH1675/BH16105 | 30 | 5 | 150 | 24/3600 | 10/1500 |
| BH1814/BH1816/BH1917 | 25 | 5 | 125 | 24/3000 | 10/1250 |
| BH2321 | 25 | 5 | 125 | 26/3250 | 10/1250 |
| BH28245 | 16 | 5 | 80 | 26/2080 | 10/800 |
| BH3835 | 9 | 5 | 45 | 24/1080 | 10/450 |

4) Coding rules for the back printing of COB



Coding rules

<u>B H19 17-06 12 J 18W 30 S-KV4</u>



Test items

| Туре | | Test items | standards | Test conditions | duration | Sample quantity | result |
|---------------------|------------------------------|-----------------------------------|-----------------------------|--|--------------|--------------------|--------|
| | | Temp. cycle | JEITA ED-4701 100 105 | -40℃→25℃→ 100℃→25℃ 30Min 5Min 30Min 5Min | (300 cycles) | 5 | 0/5 |
| Environment test | Storage with high temp | JEITA ED-4701 200 201 | Ta=100℃ | 168 hrs | 5 | 0/5 | |
| | Storage with low temp | JEITA ED-4701 200 202 | Ta=-40℃ | 168 hrs | 5 | 0/5 | |
| Life test | room temp | - | Ta=25℃ @lf | 1000/3000/600 0 /hrs | 1 | 0/1 | |
| | | high temp | - | Ta=85℃ @lf | 1000 hrs | 1 | 0/1 |
| | | high temp and high humidity | - | Ta=85℃ Rh=85% @If | 1000 hrs | 1 | 0/1 |
| | | High power with Room Temp | - | @1.5*lf | 720 hrs | 1 | 0/1 |
| | | Soldering resistance | IEC62717 | @If Tc=85℃ 30s on/30s off | 30000cycle | 2 | 0/2 |

Announcements

1) Storage condition

The storage environment humidity is <60%, the temperature is maintained at 20°C-30°C.Once the COB light sources have been unsealed, please install them within 168H; if it is not used up within 168H, please vacuum it and keep it sealed. After sealing, the effective use period is 1 year.

2) Application notice

When welding, the soldering iron should be properly grounded. When manual welding, the temperature of the iron must be lower than 350°C, welding time shall not exceed 3 seconds and shall be cooled to room temperature before welding again. When welding, no external force should be put on the colloidal surface and the surrounding dam glue (such as pressure, friction or sharp metal nails, etc.) or it will cause deformation of gold wire or broken wire...

In order to reduce the contact thermal resistance during assembling, please note that the thermal conductivity paste coating is uniform with proper distribution area, too little thermal conductivity paste or uneven application level is not okay. When using thermal conductive rubber pad, make sure that the base plate and thermal conductive rubber pad are in complete contact after screw installation, No hollow space is allowed.

After welding, please do not let the heat conduction silicon grease, oil... to the luminous surface, dirt can be removed with an air gun, do not use sulfur, chlorine element liquid or washing board water to clean ,Air gun pressure: 0.5mpa, time 1-2 seconds, distance: more than 20cm apart.

3) Electrostatic protection

This product is sensitive to static electricity, so effective protective measures must be taken when using this product to effectively prevent the damage of LED light source from static electricity and surge. When the high voltage current generated by static electricity exceeds the maximum rating of LED light source, the LED light source will be damaged or even completely invalid. Therefore, Customers should take effective measures to prevent static electricity and surge when using the products. Suggested grounding resistance is 10Ω or less.

4) Over-temperature, over current protection

Do not press the luminous silicon surface at any time to avoid bad effect or even ineffective to the COB. It is recommended to design grounding circuit for the whole lamp design.



The working humidity is between 50% and 80%, and the working environment is between -10° C and 85° C, otherwise, there will be hidden dangers of electrostatic breakdown and large current impact. When using this product, please ensure that it is used within the maximum rating (maximum current and Tc and glue surface temperature) specified in this specification. Any adverse consequences arising from failure to comply with the maximum rating and description of the product specifications shall not be covered by the warranty.

5) Thermal design

A good use effect of LED light source depends on the thermal resistance of LED light source, external thermal resistance, power loss and ambient temperature.

High junction temperature of LED will affect the light flux and the working life of the light source. Full consideration of these factors is highly recommended in heat dissipation design.